

100V N-Channel Enhancement Mode MOSFET

Voltage 100 V Current 88 A

Features

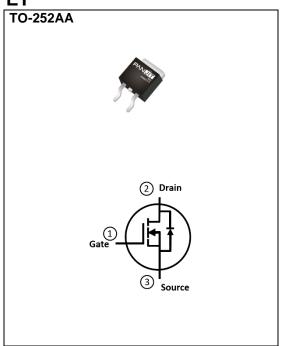
- RDS(ON), VGS@10V, ID@20A<7.4 $m\Omega$
- RDS(ON), VGS@4.5V, ID@10A<11m Ω
- Excellent FOM
- Logic Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: TO-252AA Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.3217 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current(Note 3)	T _C =25°C		88		
	T _C =100°C	I _D	62	Α	
Pulsed Drain Current(Note 1)	T _C =25°C	I _{DM}	340		
Power Dissipation	T _C =25°C	Б	115	W	
	T _C =100°C	Po	58		
Continuous Drain Current(Note 4)	T _A =25°C		14	А	
	T _A =70°C	I _D	12		
Power Dissipation	T _A =25°C	Do	3	W	
	T _A =70°C	Pb	2.1		
Single Pulse Avalanche Current(Note 5)		I _{AS}	47	А	
Single Pulse Avalanche Energy ^(Note 5)		Eas	181	mJ	
Operating Junction and Storage Temperature Range		T_{J}, T_{STG}	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	1.3	°C/W	
	Junction to Ambient	R _{θJA}	50		



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	100	-	-		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA 1.5		2.1	3	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	6	7.4	mΩ	
		V _{GS} =4.5V, I _D =10A	-	8.5	11		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA	
Dynamic ^(Note 6)							
Total Gate Charge	Qg	V _{DS} =50V, I _D =20A,	-	62	-	nC	
Gate-Source Charge	Qgs		-	11	-		
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	18	-		
Input Capacitance	Ciss	.,	-	2658	-	pF	
Output Capacitance	Coss	V _{DS} =50V, V _{GS} =0V,	-	381	-		
Reverse Transfer Capacitance	Crss	f=1MHz	-	24	-		
Gate resistance	Rg	f=1MHz	-	0.9	-	Ω	
Turn-On Delay Time	td _(on)	V _{DS} =50V, I _D =20A,	-	11	-		
Turn-On Rise Time	tr		-	16	-	ns	
Turn-Off Delay Time	td _(off)	V _{GS} =10V, R _G =3Ω	-	52	-		
Turn-Off Fall Time	tf	(11010-2)	-	22	-		
Drain-Source Diode							
Diode Forward Current	Is	T 05°0	-	-	88		
Pulsed Diode Forward Current	I _{SM}	T _C =25°C	-	-	340	A	
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V	-	0.82	1.3	V	
Reverse Recovery Time	Trr	V _{GS} =0V, I _S =20A	-	56	-	ns	
Reverse Recovery Charge	Qrr	dls/dt=100A/us	-	62	-	nC	

NOTES:

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an R_{0JC}=1.3°C/W.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. Eas is calculated based on the condition of L=1mH, I_{AS}=19A, V_{DD}=30V, V_{GS}=10V. 100% test at L=0.1mH, I_{AS}=47A in production.
- 6. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

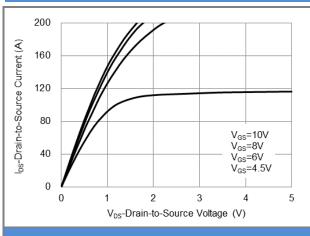


Fig.1 On-Region Characteristics

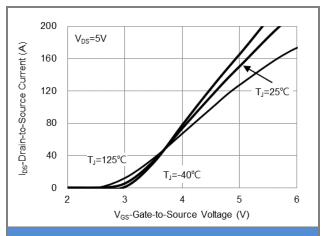


Fig.2 Transfer Characteristics

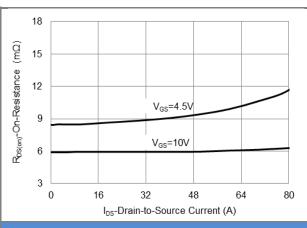


Fig.3 On-Resistance vs. Drain Current

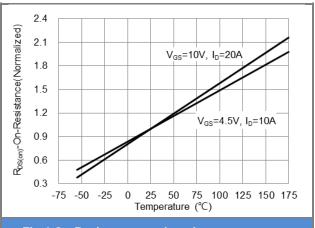
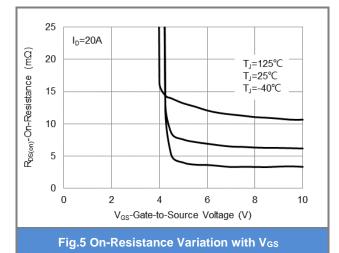


Fig.4 On-Resistance vs. Junction temperature



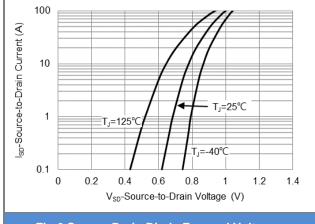


Fig.6 Source-Drain Diode Forward Voltage



TYPICAL CHARACTERISTIC CURVES

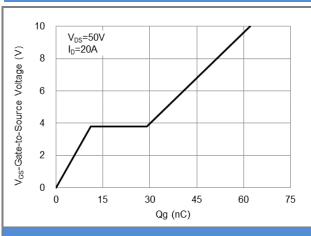


Fig.7 Gate-Charge Characteristics

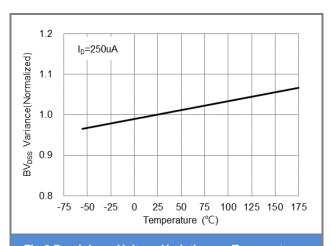


Fig.8 Breakdown Voltage Variation vs. Temperature

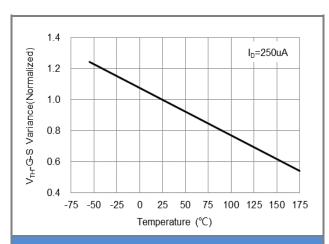


Fig.9 Threshold Voltage Variation with Temperature

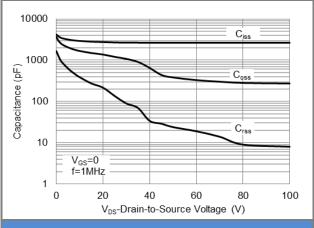
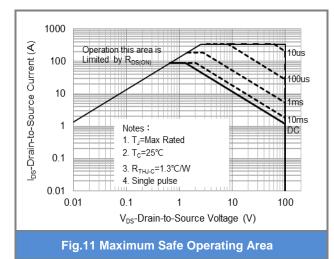


Fig.10 Capacitance vs. Drain-Source Voltage



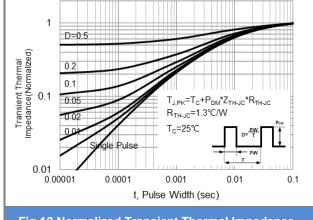


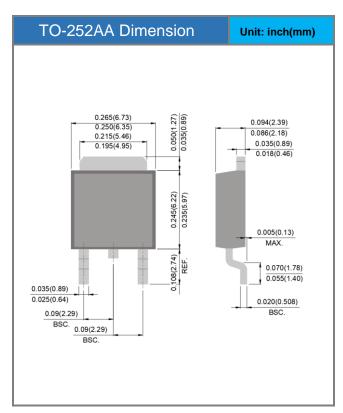
Fig.12 Normalized Transient Thermal Impedance

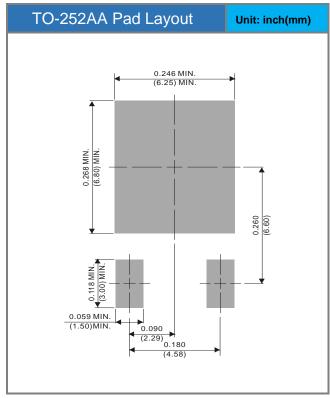


Product and Packing Information

Part No.	Package Type	Packing Type	Marking		
PJD70N10SA-AU	TO-252AA	3K pcs / 13" reel	70N10SA		

Packaging Information & Mounting Pad Layout







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